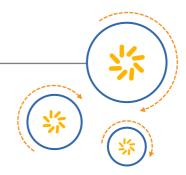


RF360 Europe GmbH
A Qualcomm – TDK Joint Venture



SAW components

SAW duplexer LTE band 7

Series/type: B1230

Ordering code: B39272B1230P810

Date: September 06, 2017

Version: 2.0

RF360 products mentioned within this document are offered by RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").

RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

© 2017 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.



SAW duplexer 2535 / 2655 MHz

Data sheet

These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm and Qualcomm RF360 are trademarks of Qualcomm Incorporated, registered in the United States and other countries. RF360 is a trademark of Qualcomm Incorporated. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



SAW duplexer 2535 / 2655 MHz

Data sheet

Table of contents

2 Features 4 3 Package 5 4 Pin configuration 5 5 Matching circuit 6 6 Characteristics 7 7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26	1 Application	4
3 Package 5 4 Pin configuration 5 5 Matching circuit 6 6 Characteristics 7 7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26		
5 Matching circuit 6 6 Characteristics 7 7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26		
5 Matching circuit 6 6 Characteristics 7 7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26	4 Pin configuration	5
6 Characteristics 7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26		
7 Maximum ratings 12 8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26		
8 Transmission coefficients 13 9 Reflection coefficients 16 10 EVMs 17 11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26		
10 EVMs		
11 Packing material 19 12 Marking 23 13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26	9 Reflection coefficients.	16
12 Marking. 23 13 Soldering profile. 24 14 Annotations. 25 15 Cautions and warnings. 26	10 <u>EVMs</u>	17
13 Soldering profile 24 14 Annotations 25 15 Cautions and warnings 26	11 Packing material	19
14 Annotations 25 15 Cautions and warnings 26	12 Marking	23
14 Annotations 25 15 Cautions and warnings 26	13 Soldering profile	24
15 <u>Cautions and warnings</u> 26		
Important notes 27	15 <u>Cautions and warnings</u>	26
<u></u>	Important notes.	27



SAW duplexer 2535 / 2655 MHz

Data sheet

1 Application

- Low-loss SAW duplexer for mobile telephone LTE Band 7 systems
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 70 MHz
- 50 Ω single-ended in both in Antenna-Rx and Tx-Antenna paths.

2 Features

- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.475 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)



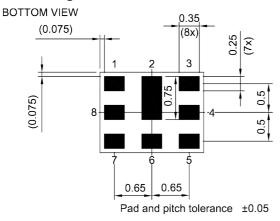
Figure 1: Picture of component with example of product marking.



SAW duplexer 2535 / 2655 MHz

Data sheet

3 Package

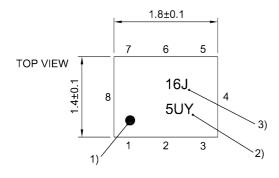


4 Pin configuration

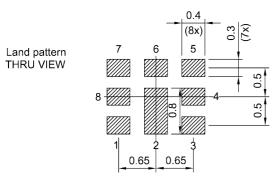
- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, 8 Ground

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.475 mm (max.). See Sec. Package information (p. 26).



SAW components B1230
SAW duplexer 2535 / 2655 MHz

Data sheet

5 Matching circuit

■ L_{p6} = 2.7 nH

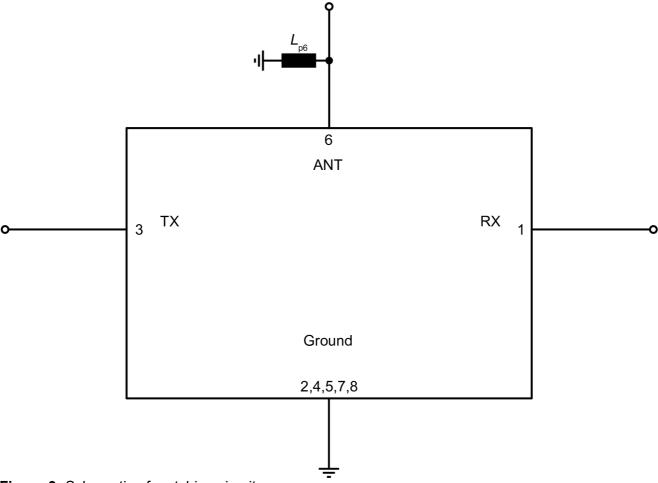


Figure 3: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.



SAW duplexer 2535 / 2655 MHz

Data sheet

6 Characteristics

6.1 TX – ANT

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TY} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 2.7 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics TX – ANT				$\begin{array}{c} \textbf{min.} \\ \textbf{for} \ \textit{T}_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	SPEC —	2535	SPEC	MHz
Maximum insertion attenuation			α_{max}				
	2500 2570	MHz	IIIdx	_	1.8	2.7	dB
Amplitude ripple (p-p)			Δα				
	2500 2570	MHz		_	0.8	1.7	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	2500 2570	MHz		_	1.6	2.0	
@ ANT port	2500 2570	MHz		_	1.6	2.0	
Maximum error vector magnitude			$EVM_{max}^{}2)}$				
	2502.4 2567.6	MHz		_	0.6	2.0	%
Minimum attenuation							
	10 1559	MHz	$\boldsymbol{\alpha}_{\text{min}}$		40	_	dB
	1559 1563	MHz	$\boldsymbol{\alpha}_{\text{min}}$		40	_	dB
	1565.42 1573.37	4 MHz	$\boldsymbol{\alpha}_{\text{min}}$		40	_	dB
	1573.374 1577.46	6 MHz	$\boldsymbol{\alpha}_{\text{min}}$	35	40	_	dB
	1577.466 1585.42	MHz	$\boldsymbol{\alpha}_{\text{min}}$	35	40	_	dB
	1597.552 1605.88	6 MHz	α_{min}	35	40	_	dB
	1605.886 1680	MHz	α_{min}	35	39	_	dB
	1805 1880	MHz	$\boldsymbol{\alpha}_{\text{min}}$		39	_	dB
	1900 1920	MHz	$\boldsymbol{\alpha}_{\text{min}}$		39	_	dB
	2010 2025	MHz	$\boldsymbol{\alpha}_{\text{min}}$	35	39	_	dB
	2110 2170	MHz	$\boldsymbol{\alpha}_{_{min}}$	35	39	_	dB
	2402 2440	MHz	$\boldsymbol{\alpha}_{\text{min}}$		52	_	dB
	2403 2421	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	54 ⁴⁾	56	_	dB
	2408 2426	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	53 ⁴⁾	55	_	dB
	2413 2431	MHz	$\alpha_{\text{WLAN,min}}^{ 3)}$	524)	54	_	dB
	2418 2436	MHz	$\alpha_{\text{WLAN,min}}^{}3)}$	52 ⁴⁾	54	_	dB
	2423 2441	MHz	$\alpha_{\text{WLAN,min}}^{3)}$	52 ⁴⁾	54	_	dB
	2428 2446	MHz	$\alpha_{\text{WLAN,min}}^{3)}$	52 ⁴⁾	54	_	dB
	2433 2451	MHz	$\alpha_{\text{WLAN,min}}^{3)}$	52 ⁴⁾	55	_	dB
	2438 2456	MHz	$\alpha_{\text{WLAN,min}}^{3)}$	52 ⁴⁾	56	_	dB



SAW duplexer 2535 / 2655 MHz

Characteristics TX – ANT				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
	2440 2460	MHz	α_{min}	40	47	_	dB
	2443 2461	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	494)	53	_	dB
	2448 2466	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	464)	49	_	dB
	2453 2471	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	444)	47	_	dB
	2458 2476	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	35 ⁴⁾	43	_	dB
	2463 2481	MHz	$\alpha_{\text{WLAN,min}}^{\qquad 3)}$	21 ⁴⁾	30	_	dB
	2470 2474	MHz	$\boldsymbol{\alpha}_{_{min}}$	16	41	_	dB
	2474 2500	MHz	$\alpha_{_{min}}$	0.5	1.7	_	dB
	2590 2620	MHz	$\alpha_{_{min}}$		4	_	dB
	2620 2690	MHz	$\alpha_{_{min}}$		52	_	dB
	4900 5000	MHz	$\alpha_{_{min}}$		49	_	dB
	5000 5140	MHz	$\boldsymbol{\alpha}_{_{min}}$		48	_	dB
	5140 5280	MHz	α_{min}		48	_	dB
	7500 7710	MHz	α_{min}		30	_	dB

See Sec. Matching circuit (p. 6).

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

³⁾ Average over each WLAN channel with band width of 18 MHz.

⁴⁾ Valid for room temperature at 25°C.



SAW duplexer 2535 / 2655 MHz

Data sheet

6.2 ANT - RX

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{Tx} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 2.7 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	2655	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	2620 2690	MHz		_	1.9	2.9	dB
Amplitude ripple (p-p)			Δα				
	2620 2690	MHz		_	0.6	1.6	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	2620 2690	MHz		_	1.6	2.0	
@ RX port	2620 2690	MHz		_	1.6	2.0	
Maximum error vector magnitude			$EVM_{max}^{}2)}$				
	2622.4 2687.6	MHz		_	0.8	2.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 718	MHz		50	56	<u> </u>	dB
	45	MHz		50	90	_	dB
	718 748	MHz		50	56	_	dB
	814 849	MHz		47	54	_	dB
	832 862	MHz		47	54	_	dB
	880 915	MHz		47	53	<u> </u>	dB
	1710 1785	MHz		38	43	<u> </u>	dB
	1920 1980	MHz		37	42	_	dB
	2400 2500	MHz		40	45	_	dB
	2500 2570	MHz		45	55	_	dB
	2570 2600	MHz		3	7	–	dB
	2775 2790	MHz		40	55	_	dB
	2790 2810	MHz		40	55	_	dB
	2810 3660	MHz		39	44	_	dB
	3600 4900	MHz		39	44	_	dB
	4900 5300	MHz		35	43	_	dB
	5300 5950	MHz		32	39	_	dB
	7620 7830	MHz		15	22	-	dB
IMD product levels							
IMD2 ³⁾							
Blocker 1	120	MHz		_	-136	-110	dBm
Blocker 3	5190	MHz		_	-110	-100	dBm
IMD3 ³⁾							



SAW components	B1230
SAW duplexer	2535 / 2655 MHz

Characteristics ANT – RX			$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Blocker 2	2415	MHz	_	-105	-100	dBm

See Sec. Matching circuit (p. 6). Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141. IMD product level limits for power levels P_{TX} = 21 dBm (antenna port output power) and P_{blocker} = -15 dBm (antenna port input power).



SAW duplexer 2535 / 2655 MHz

Data sheet

6.3 TX - RX

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{Tx} = 50 \Omega$

ANT terminating impedance $Z_{\Delta NT} = 50 \Omega$ with par. 2.7 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics TX – RX					typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Minimum isolation			$\alpha_{_{min}}$				
	1574 1577	MHz		30	65	_	dB
	2500 2570	MHz		53	56	_	dB
	2620 2690	MHz		50	54	_	dB
	5000 5140	MHz		30	51	_	dB
	7500 7710	MHz		25	44	_	dB

See Sec. Matching circuit (p. 6).



SAW components

B1230

SAW duplexer

2535 / 2655 MHz

Data sheet

7 Maximum ratings

Storage temperature	T _{STG} ¹⁾ = -40 °C +85 °C	
DC voltage	$ V_{DC} = 5.0 \text{ V (max.)}^{2}$	
ESD voltage		
	$V_{\rm ESD}^{3)} = 50 \text{V (max.)}$	Machine model.
	V _{ESD} ⁴⁾ = >100 V	Human body model.
	$V_{\rm ESD}^{5)} = >100 \text{ V}$	Charged device model.
Input power	P _{IN}	
@ TX port: 2500 2570 MHz	29 dBm	Continuous wave for 5000 h @ 50 °C.
@ TX port: other frequency ranges	10 dBm	Continuous wave for 5000 h @ 50 °C.

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

²⁾ 168h Damp Heat Steady State acc. IEC 60068-2-67 Cy.

³⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁵⁾ According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.



SAW duplexer 2535 / 2655 MHz

Data sheet

8 Transmission coefficients

8.1 TX - ANT 0.0 α/dB 1.0 2.0 770 3.0 4.0 5.0 2600 2460 2480 2500 2520 2540 2560 2580 2620 f/MHz 0.0 20.0 40.0 60.0 2400 2450 2500 2550 2600 2650 2700 2750 2800 *f*/MHz 0.0 20.0 40.0 60.0 80.0 1000 2000 3000 4000 5000 6000

Figure 4: Attenuation TX – ANT.

f/MHz-



SAW components

B1230

SAW duplexer

2535 / 2655 MHz

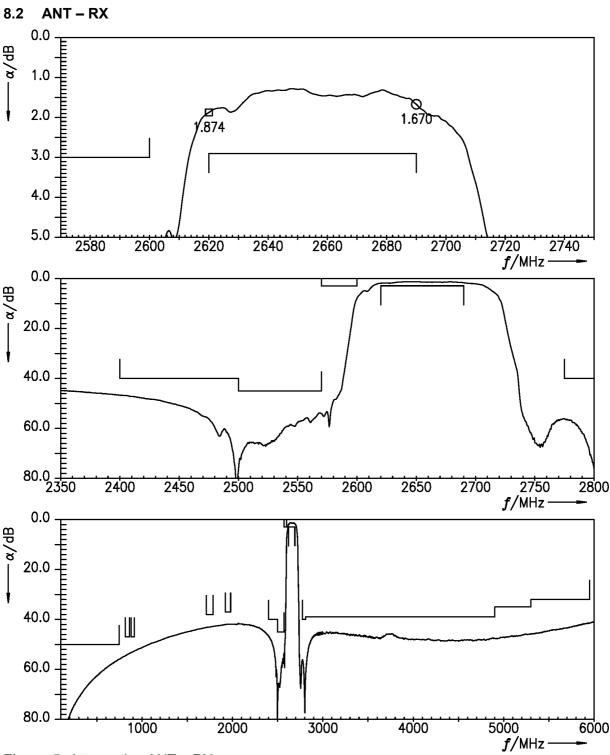


Figure 5: Attenuation ANT – RX.



SAW components

B1230

SAW duplexer

2535 / 2655 MHz

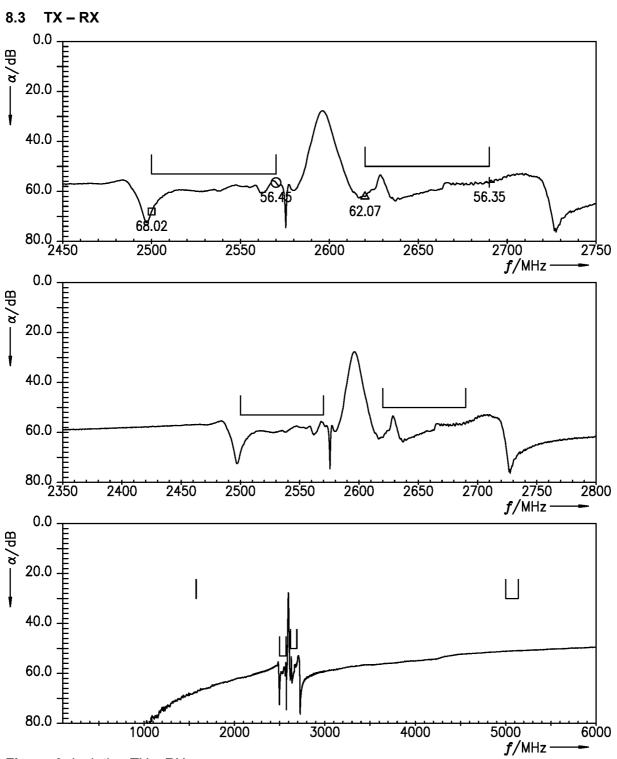


Figure 6: Isolation TX – RX.



SAW duplexer 2535 / 2655 MHz

Data sheet

9 Reflection coefficients

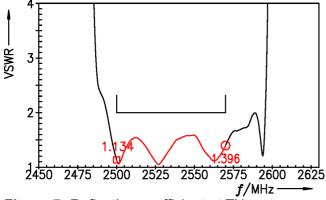
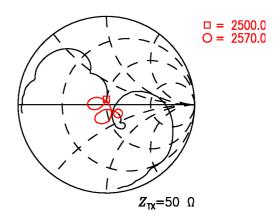


Figure 7: Reflection coefficient at TX port.



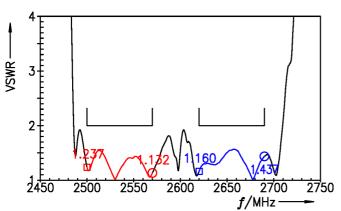
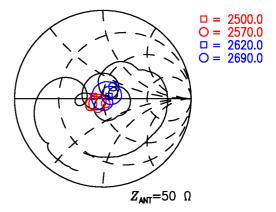
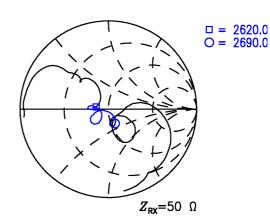


Figure 8: Reflection coefficient at ANT port.





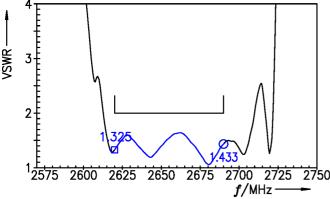


Figure 9: Reflection coefficient at RX port.



SAW components B1230
SAW duplexer 2535 / 2655 MHz

Data sheet

10 EVMs

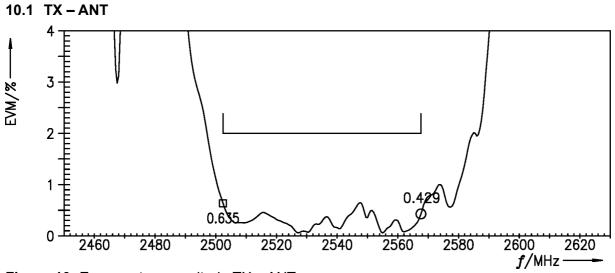


Figure 10: Error vector magnitude TX – ANT.



SAW components B1230
SAW duplexer 2535 / 2655 MHz

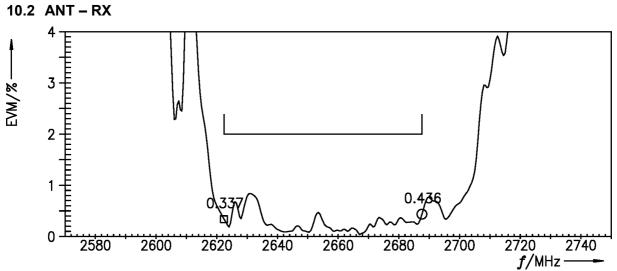


Figure 11: Error vector magnitude ANT – RX.

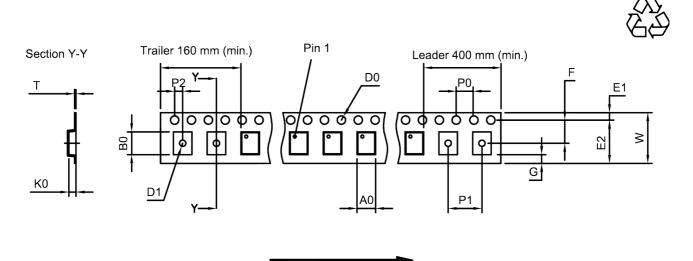


SAW duplexer 2535 / 2655 MHz

Data sheet

11 Packing material

11.1 Tape



User direction of unreeling

Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.62±0.05 mm	E	6.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	2.04±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D_0	1.5+0.1/-0 mm	(0.75 mm (min.)	Т	0.25±0.05 mm
D ₁	0.8±0.05 mm	K	0.62±0.05 mm	W	8.0±0.1 mm
E ₁	1.75±0.1 mm	P	4.0±0.1 mm		

Table 1: Tape dimensions.



SAW duplexer 2535 / 2655 MHz

Data sheet

11.2 Reel with diameter of 180 mm

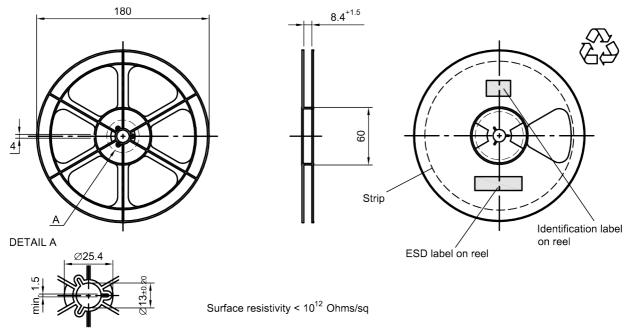


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

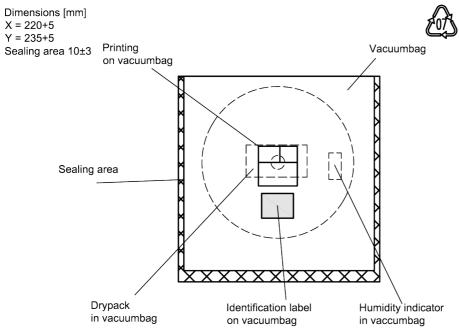


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.



SAW duplexer 2535 / 2655 MHz

Data sheet

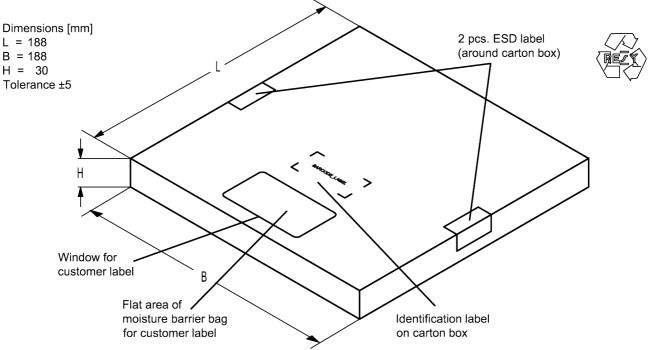


Figure 15: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

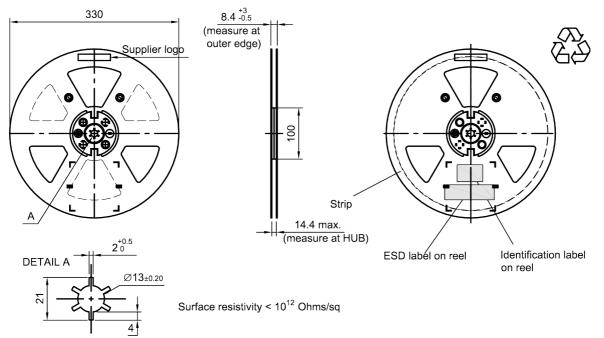


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.



SAW duplexer 2535 / 2655 MHz

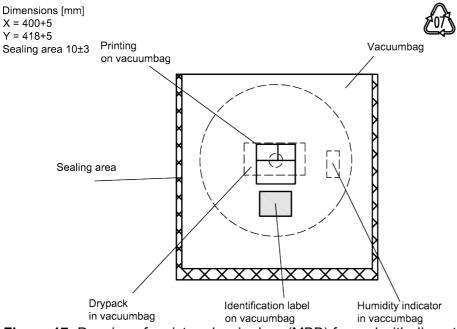


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

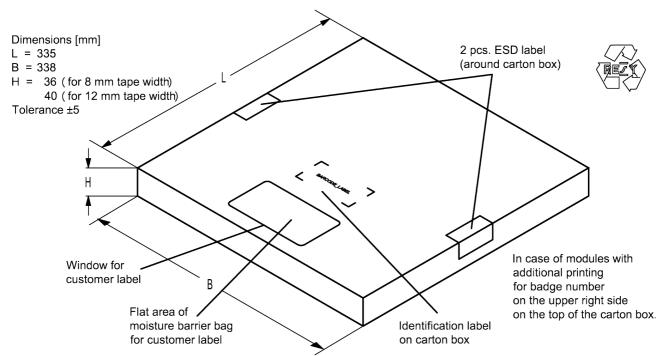


Figure 18: Drawing of folding box for reel with diameter of 330 mm.



SAW duplexer 2535 / 2655 MHz

Data sheet

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B1230 is 16E.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345

Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32		
value	code	value	code		
0	0	16	G		
1	1	17	Н		
2	2	18	J		
3	3	19	K		
4	4	20	M		
5	5	21	N		
6	6	22	Р		
7	7	23	Q		
8	8	24	R		
9	9	25	S		
10	Α	26	Т		
11	В	27	V		
12	С	28	W		
13	D	29	Х		
14	E	30	Y		
15	F	31	Z		

Adopted BASE47 code for lot number						
Decimal	Base47	Decimal	Base47			
value	code	value	code			
0	0	24	R			
1	1	25	S			
2	2	26	Т			
3	3	27	U			
4	4	28	V			
5	5	29	W			
6	6	30	X			
7	7	31	Y			
8	8	32	Z			
9	9	33	b			
10	Α	34	d			
11	В	35	f			
12	С	36	h			
13	D	37	n			
14	Е	38	r			
15	F	39	t			
16	G	40	V			
17	Н	41	\			
18	J	42	?			
19	K	43	{			
20	L	44	}			
21	M	45	<			
22	N	46	>			
23	Р					

Table 2: Lists for encoding and decoding of marking.



SAW components	B1230
SAW duplexer	2535 / 2655 MHz

Data sheet

13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	_
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

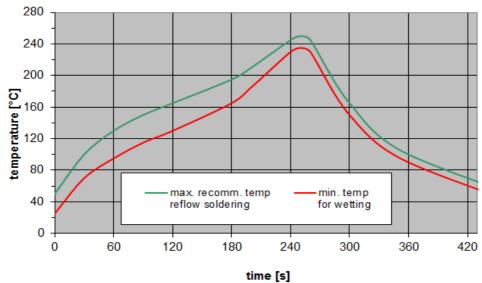


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.



SAW duplexer 2535 / 2655 MHz

Data sheet

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39272B1230P810	15000 pcs
B39272B1230P810S 5	5000 pcs

Table 4: Ordering codes and packing units.



SAW duplexer 2535 / 2655 MHz

Data sheet

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.
 - The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

单击下面可查看定价,库存,交付和生命周期等信息

>>RF360 / Qualcomm